Panasonic

MA3J7440G

Silicon epitaxial planar type

For super high speed switching For small current rectification

Features

- High-density mounting is possible
- Forward current (Average) $I_{F(AV)} = 200 \text{ mA}$ rectification is possible

Symbol Rating		Unit					
V _R	30	V					
V _{RRM}	30	V					
I _{F(AV)}	200	mA					
I_{FM}	300	mA					
I _{FSM}	1	А					
Tj	150	°C					
T _{stg}	-55 to +150	°C					
	$\begin{tabular}{c} \hline V_R \\ \hline V_{RRM} \\ \hline I_{F(AV)} \\ \hline I_{FM} \\ \hline I_{FSM} \\ \hline T_j \end{tabular}$	$\begin{tabular}{ c c c c } \hline Symbol & Rating \\ \hline V_R & 30 \\ \hline V_{RRM} & 30 \\ \hline I_{F(AV)} & 200 \\ \hline I_{FM} & 300 \\ \hline I_{FSM} & 1 \\ \hline T_j & 150 \\ \hline \end{tabular}$					

Absolute Maximum Ratings $T_a = 25^{\circ}C$

- Package
- Code
- SMini3-F2
- Pin Name
- 1: Anode
- 2: N.C.
- 3: Cathode

Marking Symbol: M1M

Internal Connection



Note) *: t = 1 s

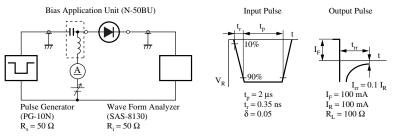
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

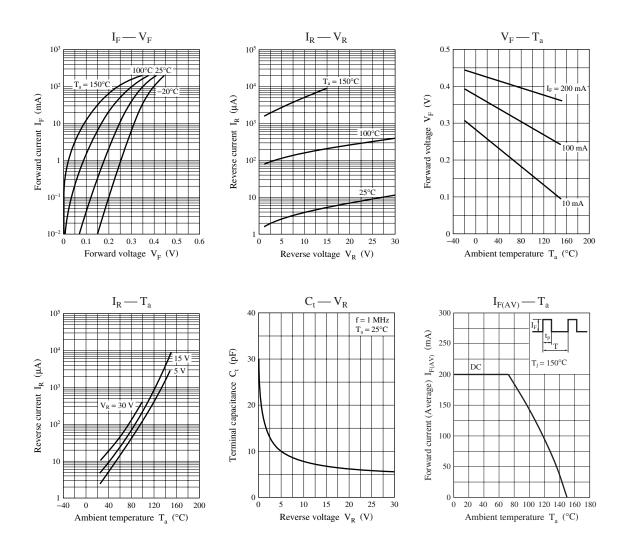
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _F	$I_F = 200 \text{ mA}$			0.55	V
Reverse current	I _R	$V_R = 30 V$			50	μΑ
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$		30		pF
Reverse recovery time *	t _{rr}	$I_F = I_R = 100 \text{ mA}$		3.0		ns
		$I_{\rm rr}$ = 0.1 I_R , $R_{\rm L}$ = 100 Ω				

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

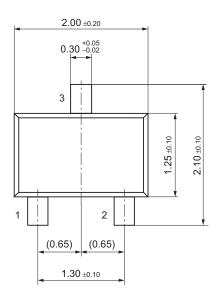
- 3. Absolute frequency of input and output is 2 GHz.
- 4. *: t_{rr} measurement circuit

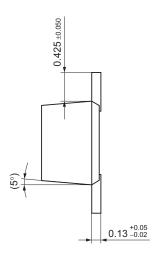


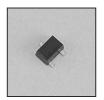


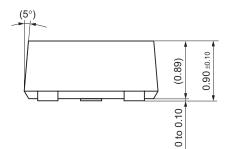
SMini3-F2

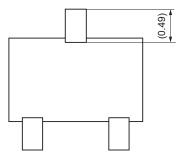
Unit: mm











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